



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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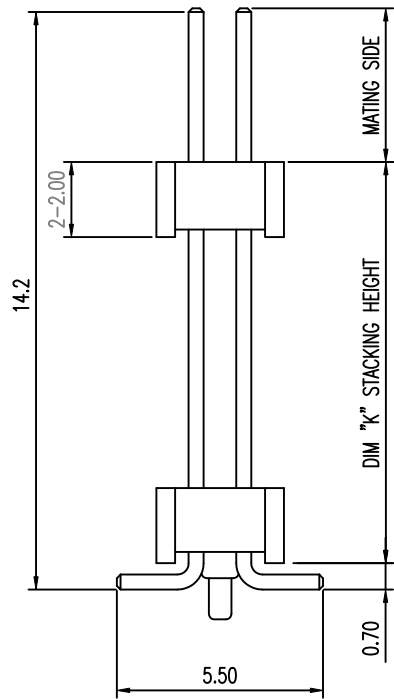
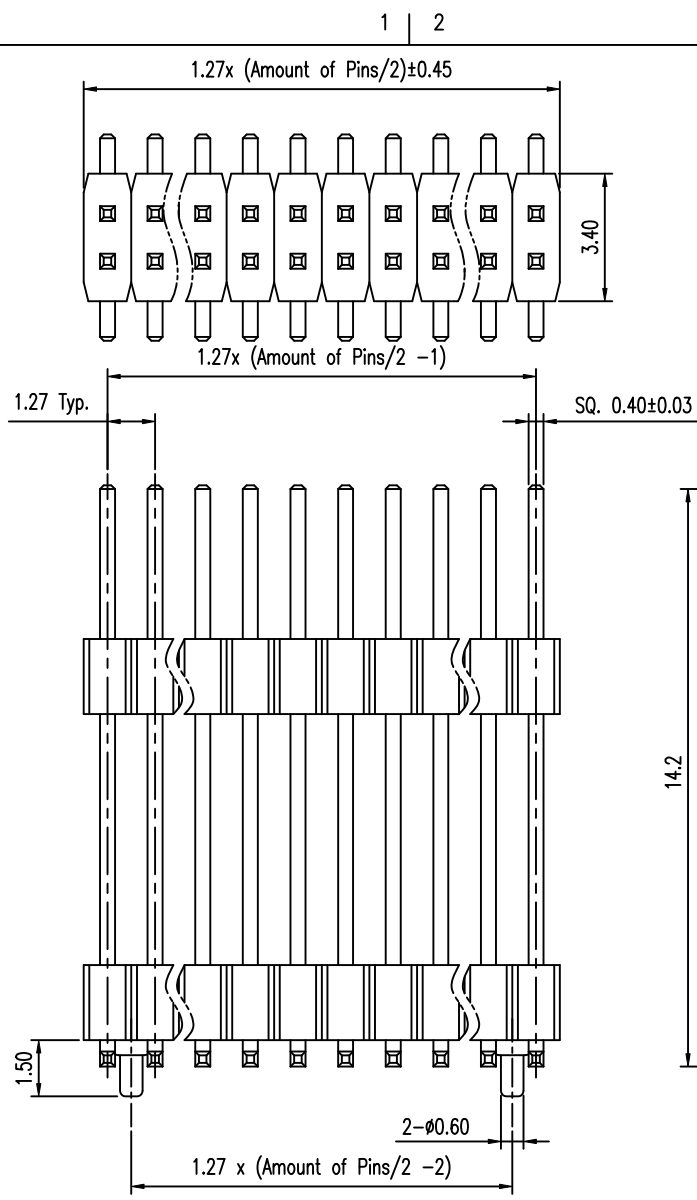
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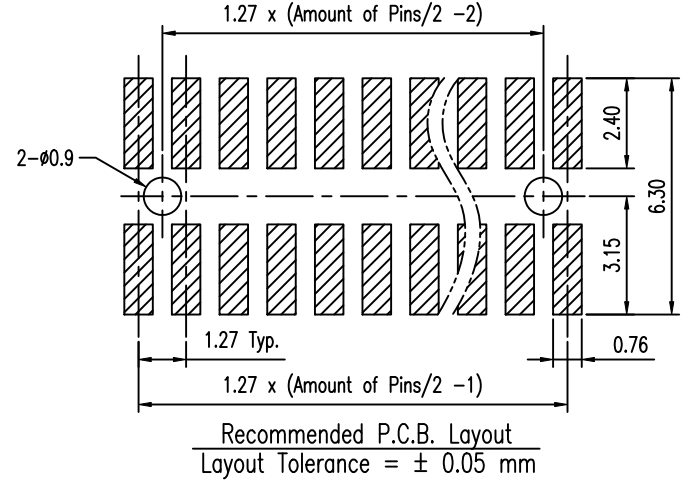


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NOTE:
 1. MATERIAL, HOUSING: NYLON 6T (E630NK), UL94V-0
 TERMINAL: C2700 H
 2. FINISH: GOLD AT CONTACT, G/F OVER 1um(40u") MIN Ni OVER ALL
 3. SPEC.: PRODUCT SPEC: GS-12-629
 PACKING SPEC: GS-14-1517
 4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C PEAK TEMP. FOR 10 SEC. IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
 5. MATING SIDE LENGTH: 2.50MM MIN.
 6. PRODUCT NUMBERING:
 200218 3 4 - XXX XX X X LF

LEAD FREE
 PLATING:
 1: G/F ALL OVER
 4: 0.25um(10u") GOLD AT CONTACT
 8: 0.76um(30u") GOLD AT CONTACT
 PACKING
 T: TUBE
 PIN COUNT
 04, 06, 08, ..., 48, 50
 (EVERY EVEN PIN)
 STACK HEIGHT "K"
 EXAMPLE: 045=4.5MM
 IN 0.5MM INCREMENT



mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY	FCI	
ltr	ecn no	dr	date	linear	.X ± 0.38	projection	www.fciconnect.com	
1	T10-0072	S.LIN	10'-5-31	angles	.XX ± 0.25		title	
					.XXX ± 0.15		1.27X1.27MM BTB STACK HD	
				dr	STERLING LIN	10'-5-20	MM	product family
				engr	STERLING LIN	10'-5-20		585
				chr	STERLING LIN	10'-5-20	scale	code
				appd	GARY HSIEH	10'-5-20	NA	size
sheet index	revision sheet	A	-				A4	20021834
		1						TWN
								sheet 1 of 1